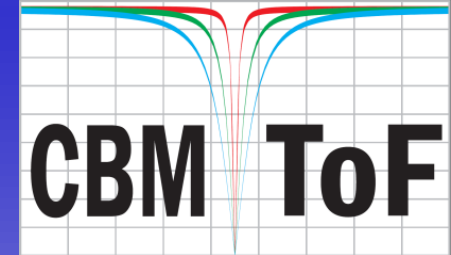


RPC 2018 – XIV Workshop on Resistive Plate Chambers and Related Detectors



The CBM Time-of-Flight wall

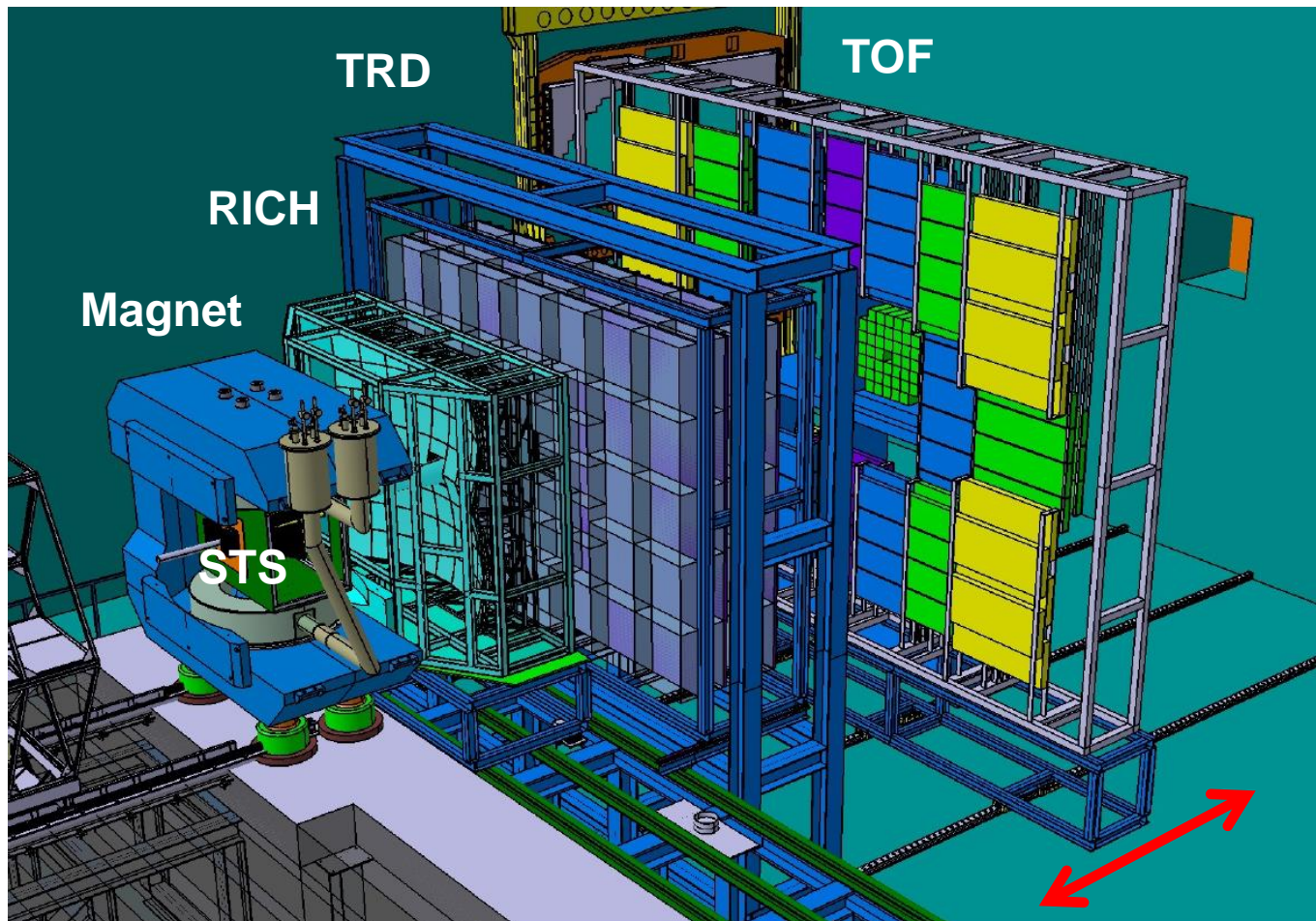
Ingo Deppner

Physikalisches Institut der Uni. Heidelberg

Outline:

- **Introduction**
- **CBM-ToF requirements**
- **TDR ToF wall design**
- **Low resistive material and the BFTC**
- **Test beam time at CERN and the MRPC1/2 prototype**
- **Pre-mass production for MRPC3a/b counter**
- **FAIR Phase 0 program**
- **Summary**

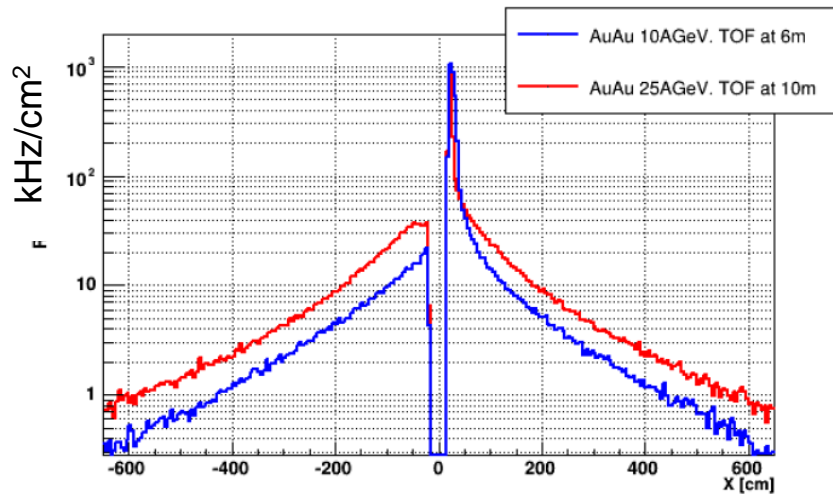
Engineering design of the CBM experiment



Nominal ToF position is between 6 m and 10 m from the target

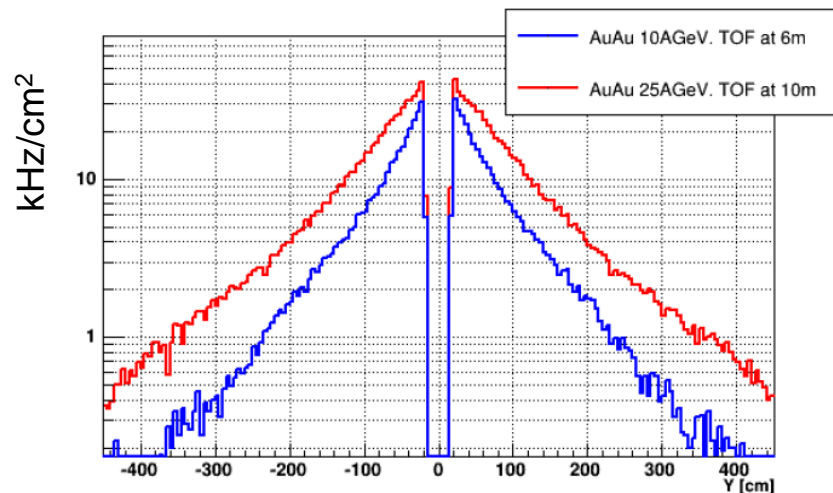
Movable design allows for optimization of the detection efficiency of weakly decaying particles (Kaons)

Interaction rate 10 MHz

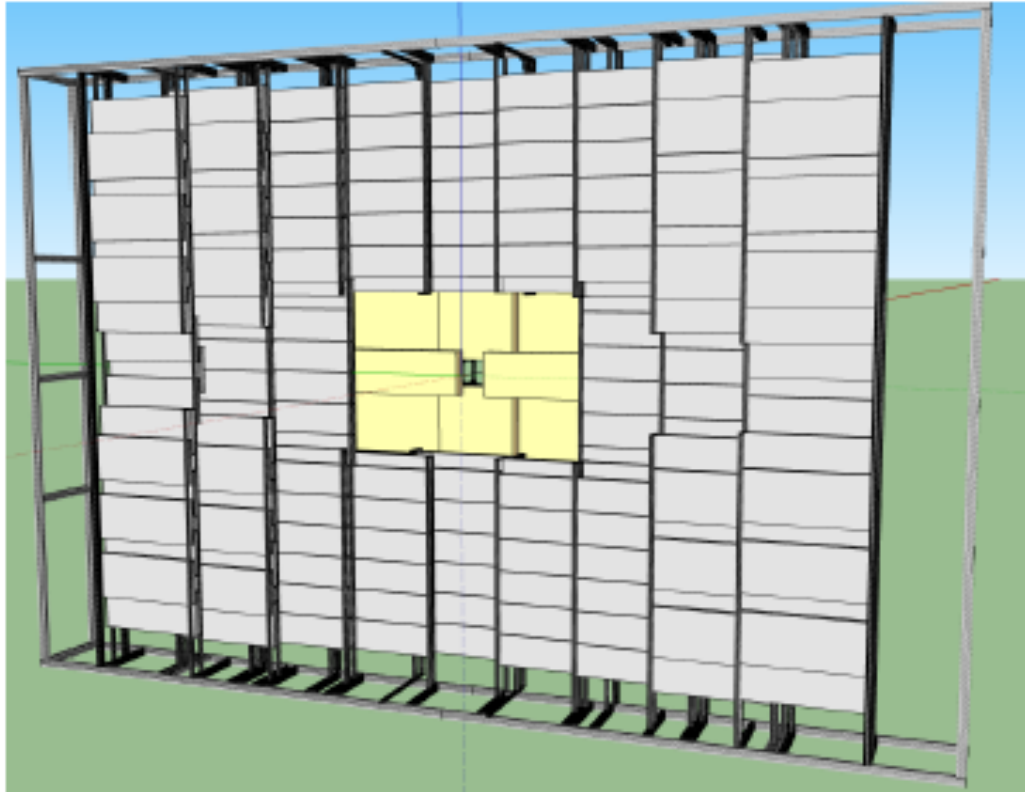


URQMD simulated charged particle flux from Au + Au events for an interaction rate of 10 MHz

- Flux ranging from 0.1 to 100 kHz/cm²
- At different regions Time-of-Flight detectors with different rate capabilities are needed



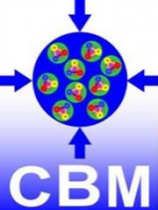
Charged hadron identification is provided by Time-of-Flight (ToF) measurement



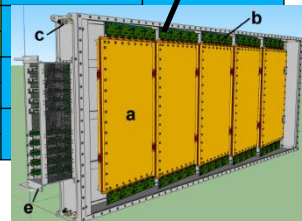
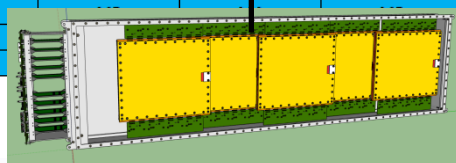
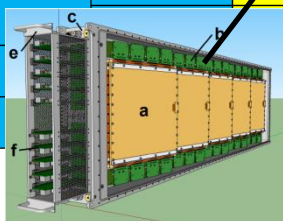
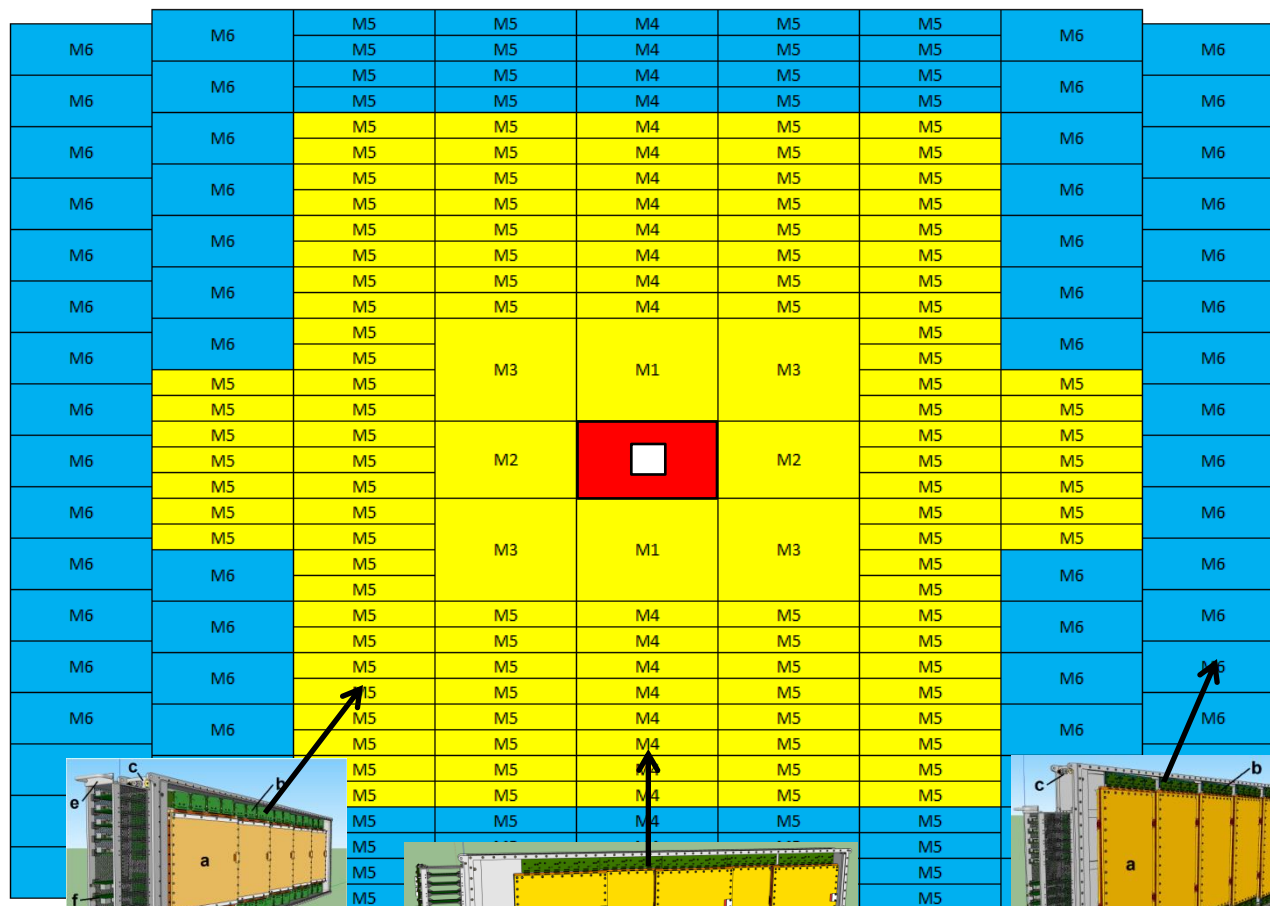
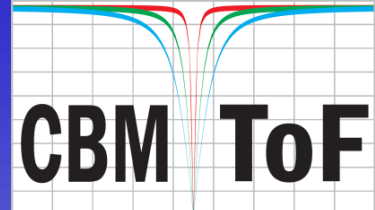
CBM-ToF Requirements




- Full system time resolution $\sigma_T \sim 80$ ps
- Efficiency > 95 %
- Rate capability ≤ 30 kHz/cm²
- Polar angular range 2.5° – 25°
- Active area of 120 m²
- Occupancy < 5 %
- Low power electronics
(~100.000 channels)
- **Free streaming data acquisition**

Multi-gap Resistive Plate Chambers (MRPC) are the most suitable ToF detectors fulfilling our requirements

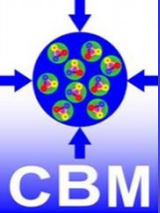


TDR ToF wall layout

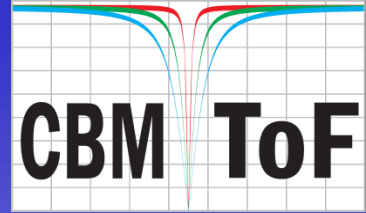


- 6 types of modules (M1 – M6) only
- A module contains several MRPC counters
-  Region containing counters equipped with float glass
-  Region containing counters equipped with low resistive glass
-  Region containing counters equipped with ceramic material





TDR ToF wall layout



M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6

- 6 types of modules (M1 – M6) only

Module notation	Number of modules	Module size mm ³	Number of MRPCs per module	Number of MRPCs in total	Number of cells per module	Number of cells in total
M1	2	1270 × 1417 × 239	32	64	2048	4096
M2	2	2140 × 705 × 239	27	54	1728	3456
M3	4	1850 × 1417 × 239	42	168	2688	10752
M4	24	1802 × 490 × 110	5	120	160	3840
M5	132	1802 × 490 × 110	5	660	160	21120
M6	62	1802 × 740 × 110	5	310	160	9920
Sum	226			1376		53184

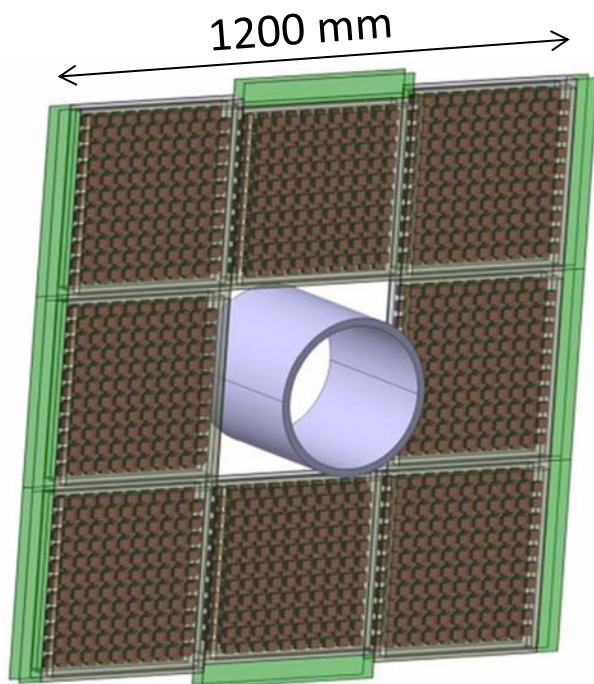
Table 3.1: Numbers and dimensions of the modules.

M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6
M6	M6	M5	M5	M4	M5	M5	M6	M6

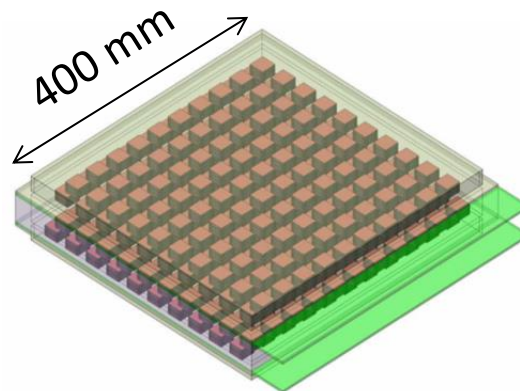
⇒ 106368 read-out channels



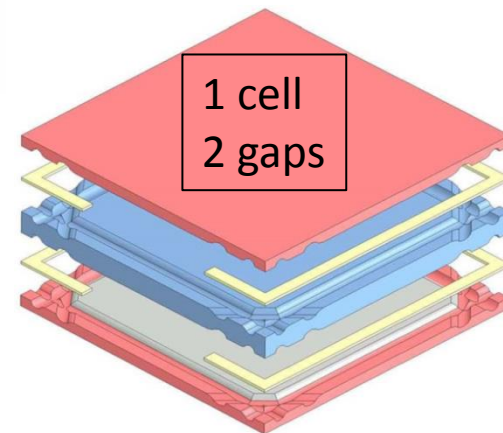
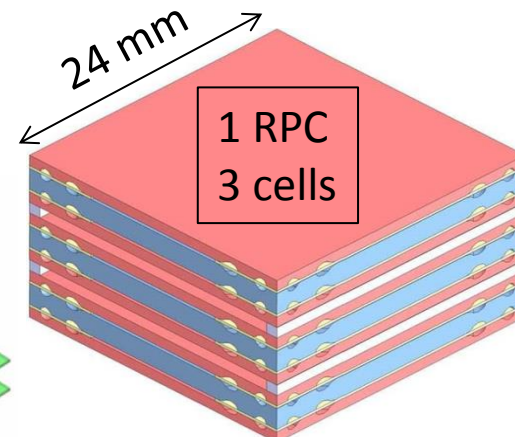
Important scopes of High Energy Heavy Ion experiments are the **start-time** and the **reaction-plane determination**. For CBM the use of RPC for the **Beam Fragmentation T_0 Counter (BFT₀C)** with low resistive radiation hard ceramics electrodes and small chess-board like single cells is under consideration.

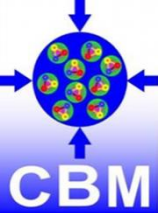


BFT₀C = 8 modules

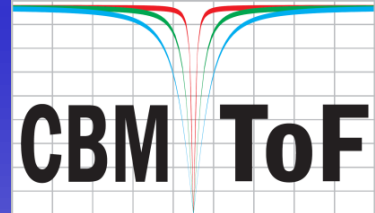


1 module
400 RPCs

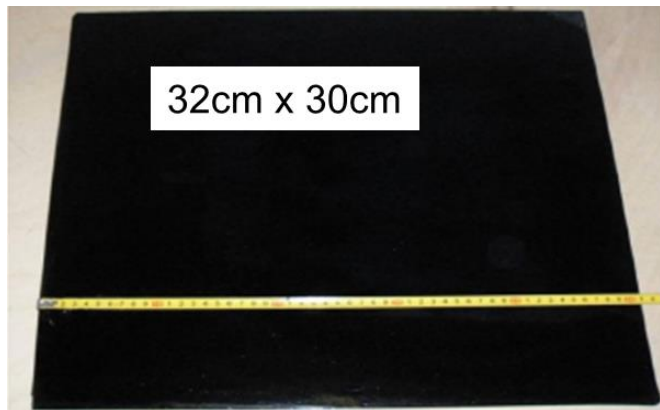




Resistive Glass Development



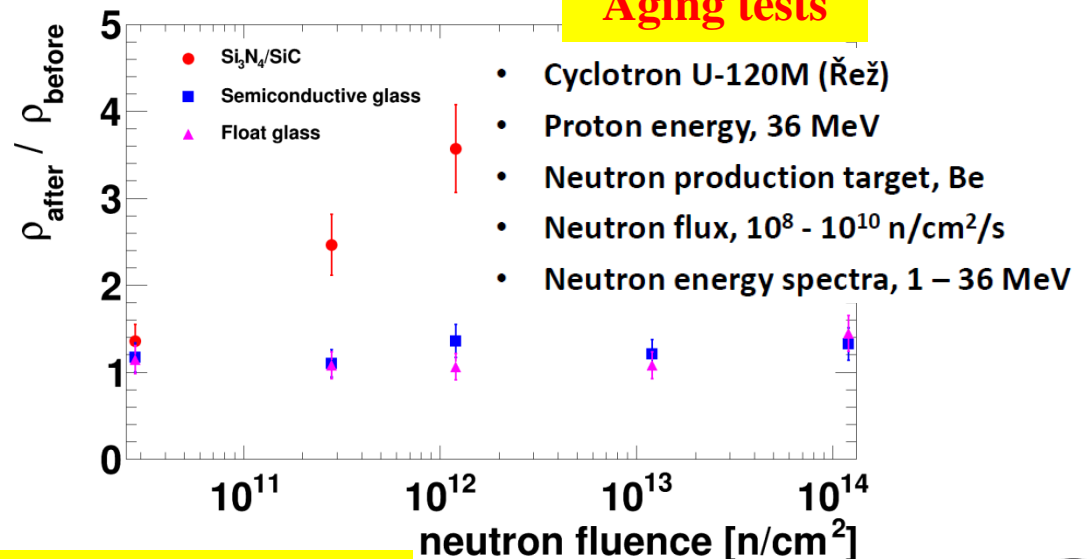
Resistive glass for high-rate MRPCs is developed in Beijing, China



Raw resistive glass material for 400 m²

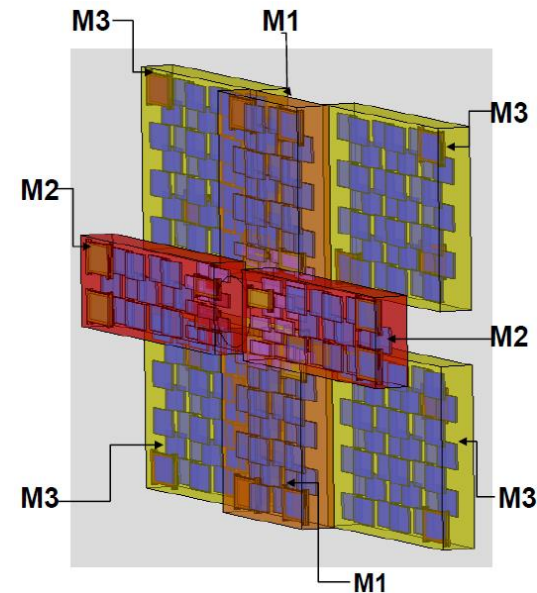
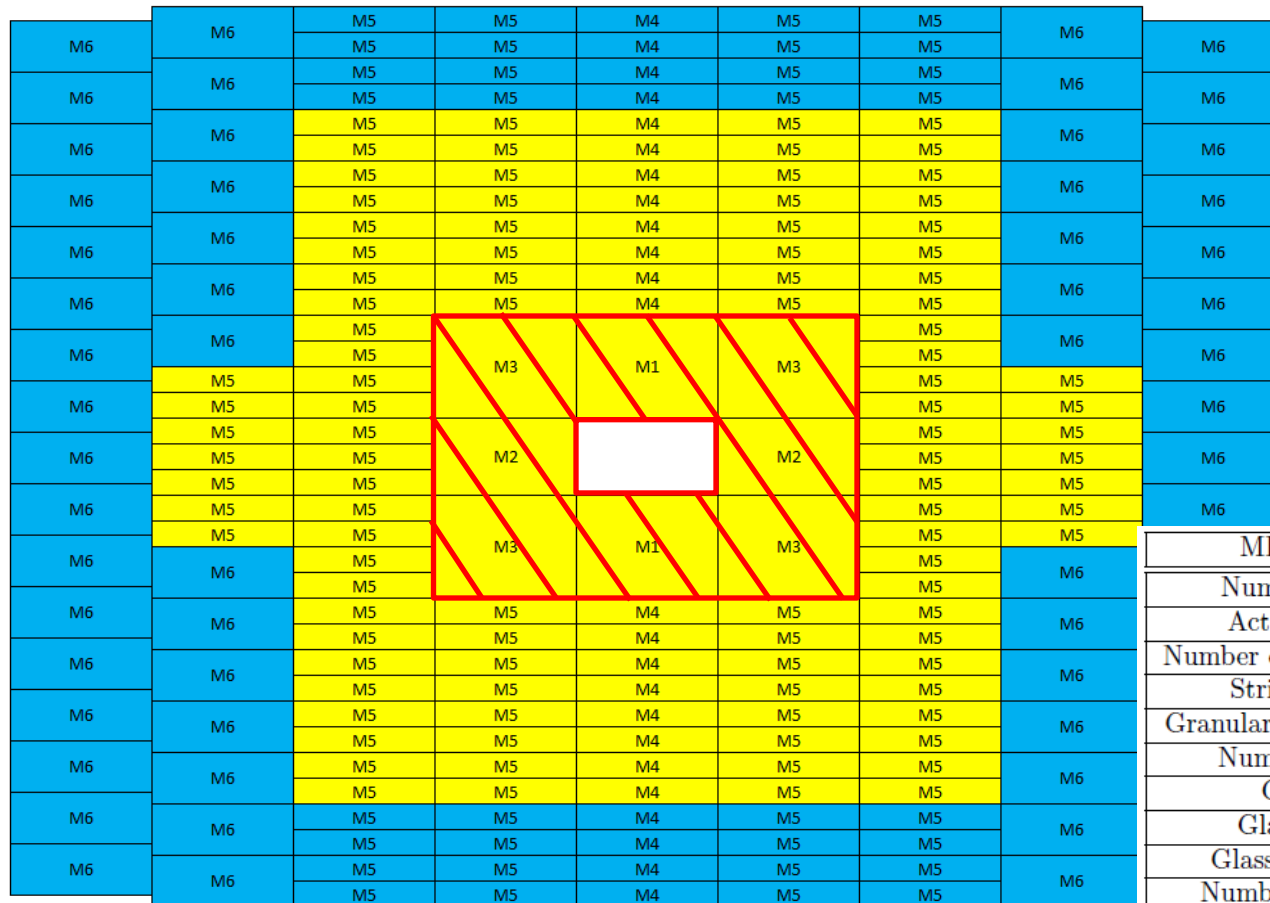
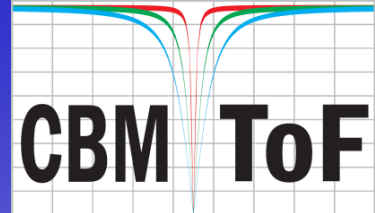
Maximal dimension	32cm × 30cm
Bulk resistivity	10 ¹⁰ Ωcm
Standard thickness	0.7, 1.1mm
Thickness uniformity	20 μm
Surface roughness	< 10nm
Dielectric constant	7.5 - 9.5
DC measurement	Ohmic behavior stable up to 1 C/cm ²

Aging tests





TDR ToF wall layout high rate region



MRPC notation	MRPC1	MRPC2
Number of MRPCs	40	246
Active area [mm ²]	300 × 100	300 × 200
Number of Strips per MRPC	64	64
Strip length [mm]	100	200
Granularity (cell size) [mm ²]	472.4	944.8
Number of gas gaps	10	10
Gap size μ m	140	140
Glass size [mm ²]	320 × 100	320 × 200
Glass thickness [mm]	0.7	0.7
Number of glass plates	12	12
Glass type	low res.	low res.
Total glass surface [m ²]	15.36	188.93

Alternative solution with Pad-MRPCs is available



Ingo Deppner

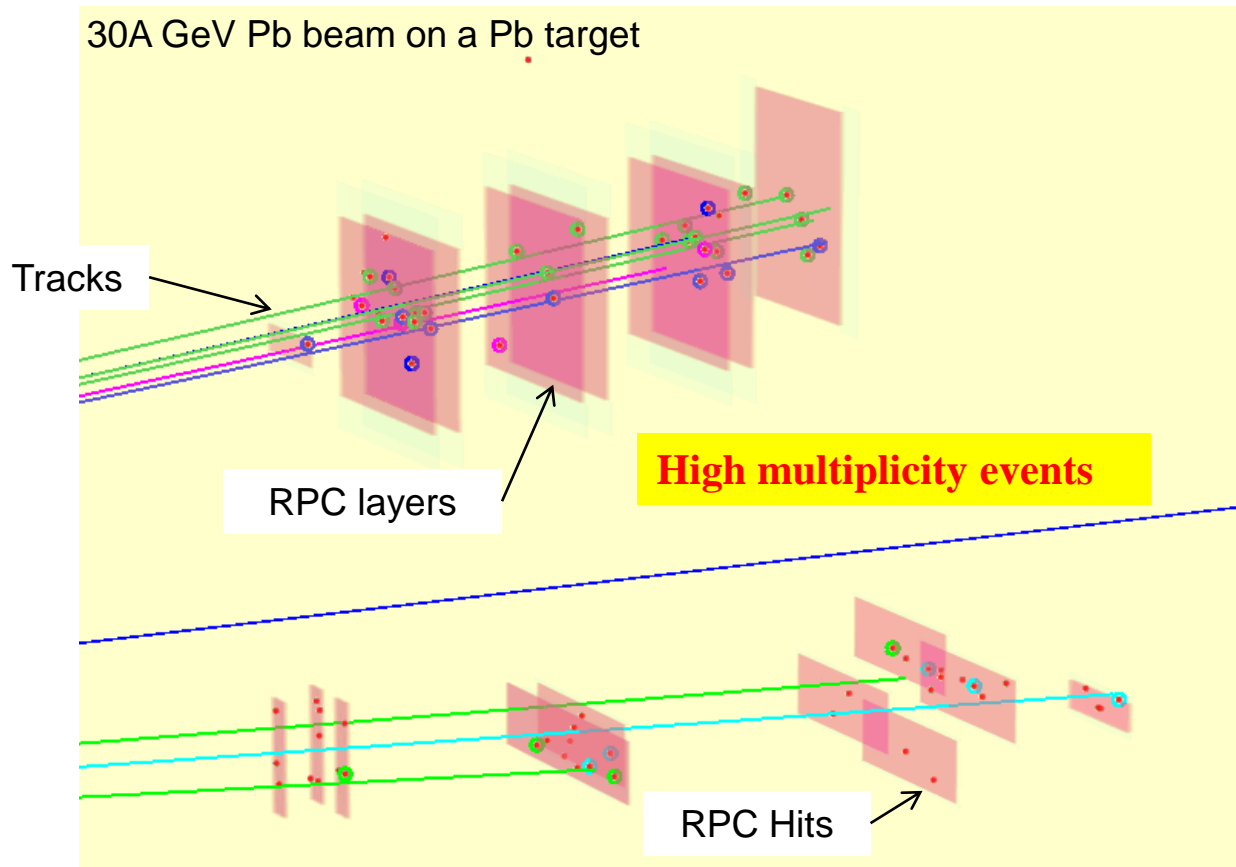
RPC 2018

Puerto Vallarta, 19 - 23.02.2018

9



Event display after position calibration

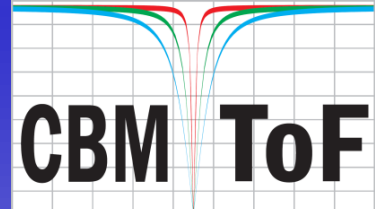


- 1 Track (blue) with hit multiplicity 8
- 2 Tracks (green) with hit multiplicity 7
- 1 Track (light blue) hit with multiplicity 6
- 1 Track (pink) with hit multiplicity 5

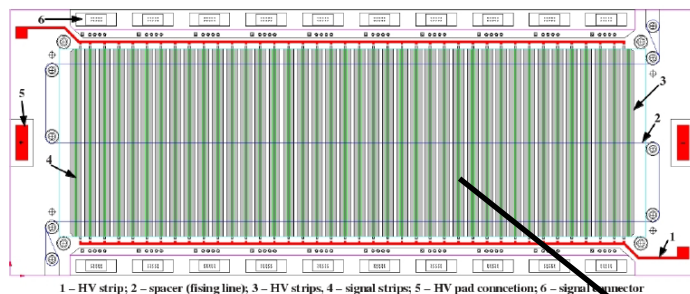
**The opportunity to reconstruct tracks offers new possibilities to analyze and study the counters in much greater detail:
multi hit response,
2d position dependencies**



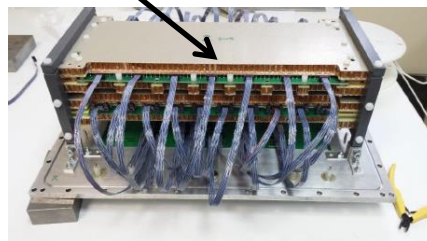
Beam-time @ SPS in Nov. 2015



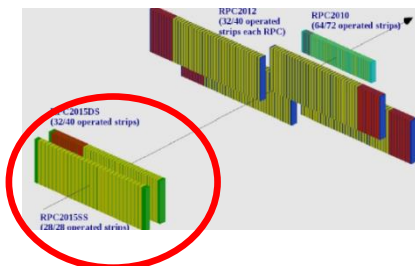
MRPC1/2 prototype developed at Bucharest



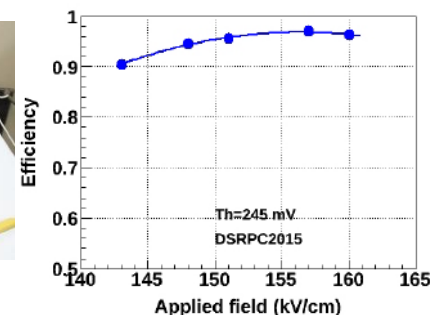
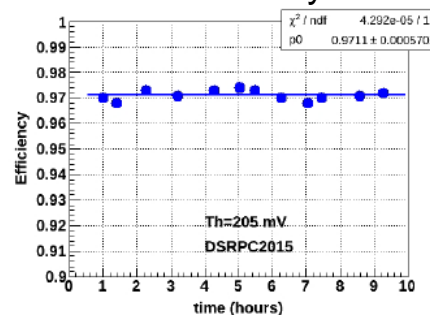
- Metal HV strip electrodes
- Innovative method of impedance matching
- Impedance independent of the granularity adjustable
- Impedance tuned to 100 Ω
- [arXiv:1708.02707](https://arxiv.org/abs/1708.02707)



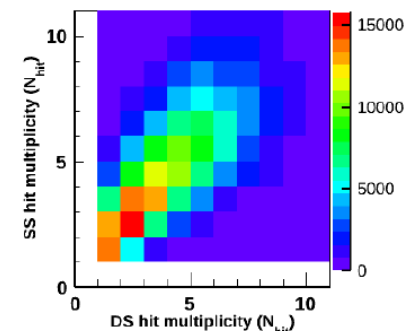
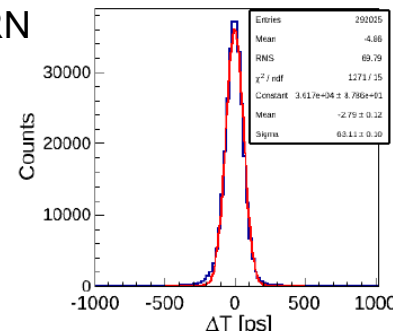
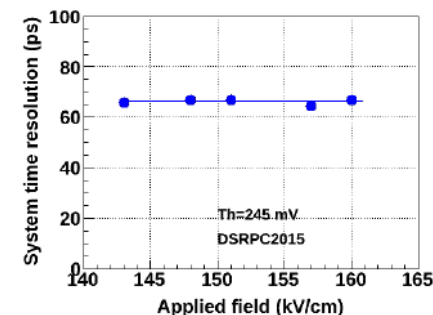
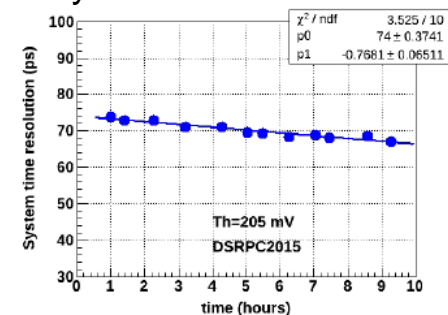
Beam time setup at CERN

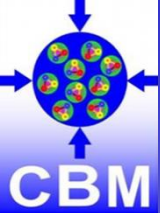


Efficiency

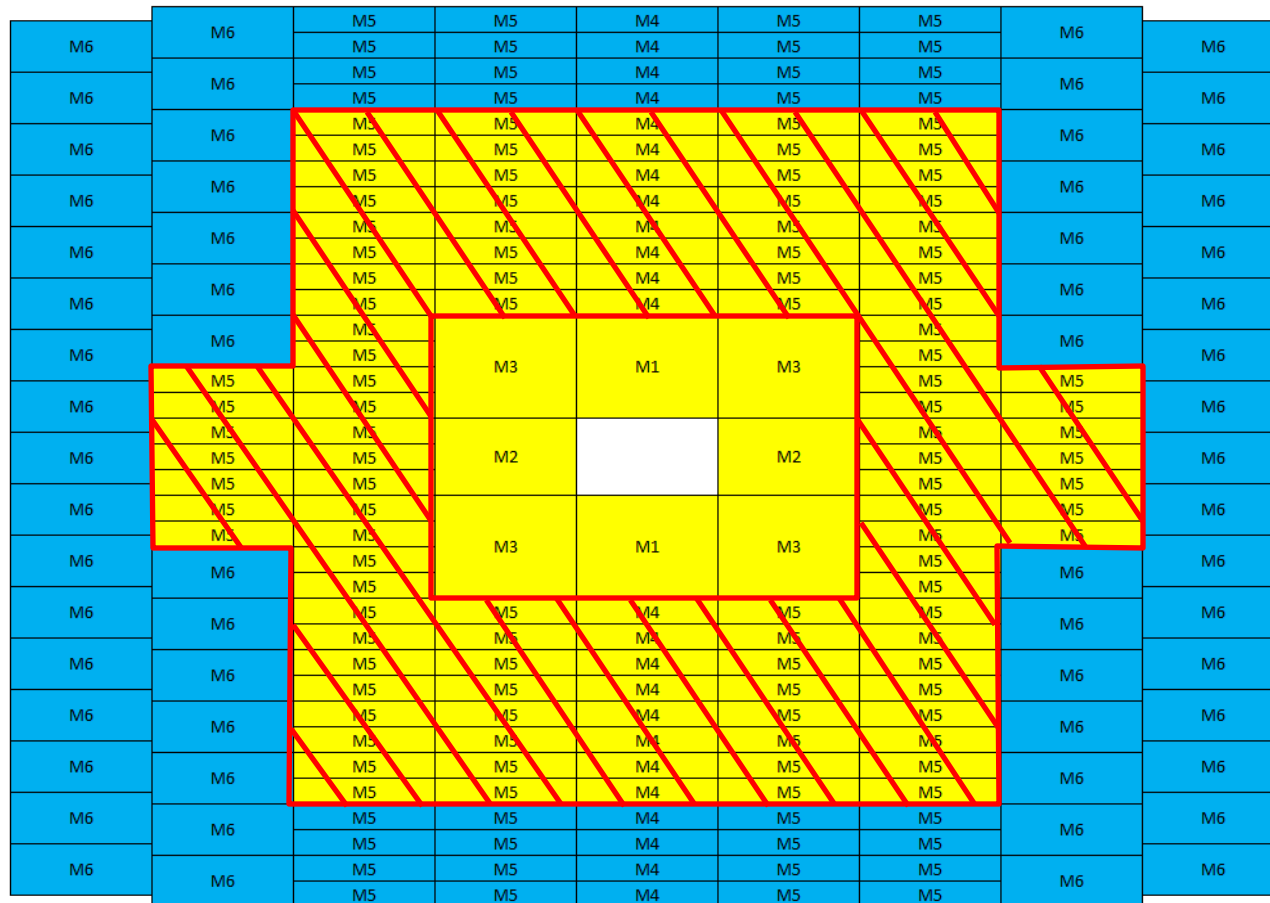
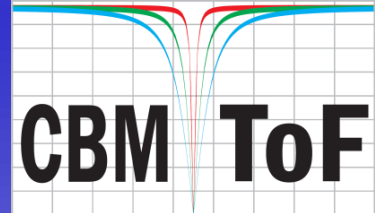


System time resolution

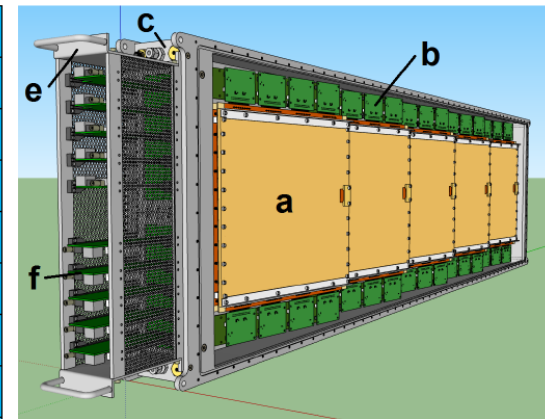




TDR ToF wall layout intermediate rate region

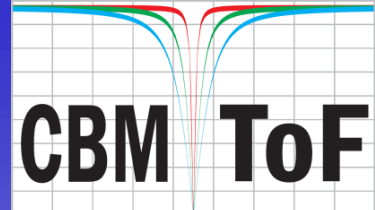


Module M5

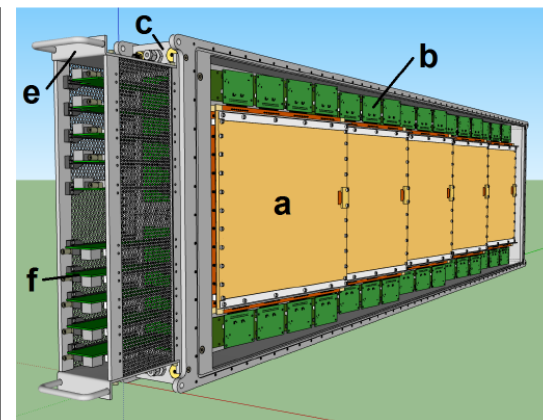


MRPC notation	MRPC3a
Number of MRPCs	580
Active area [mm ²]	320 × 270
Number of Strips per MRPC	32
Strip length [mm]	270
Granularity (cell size) [mm ²]	2700
Number of gas gaps	8
Gap size μm	250
Glass size [mm ²]	330 × 280
Glass thickness [mm]	0.7
Number of glass plates	9
Glass type	low res.
Total glass surface [m ²]	482.33



[illegible]

Module M5

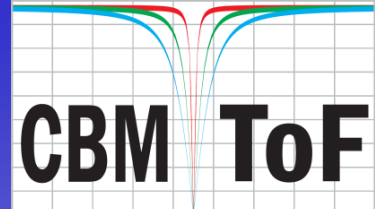


MRPC notation	MRPC3b
Number of MRPCs	200
Active area [mm ²]	320 × 270
Number of Strips per MRPC	32
Strip length [mm]	270
Granularity (cell size) [mm ²]	2700
Number of gas gaps	10
Gap size μm	230
Glass size [mm ²]	330 × 280
Glass thickness [mm]	0.28
Number of glass plates	12
Glass type	float
Total glass surface [m ²]	166.32





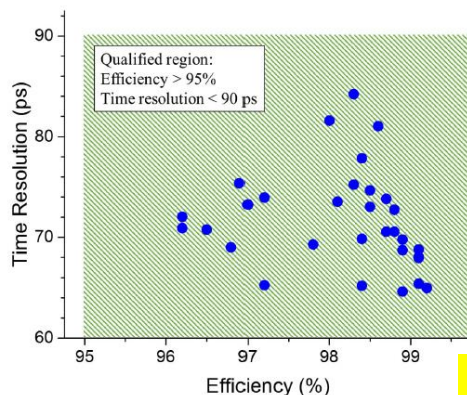
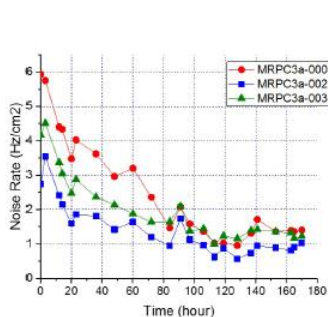
MRPC3a and MRPC3b mass production for eTOF



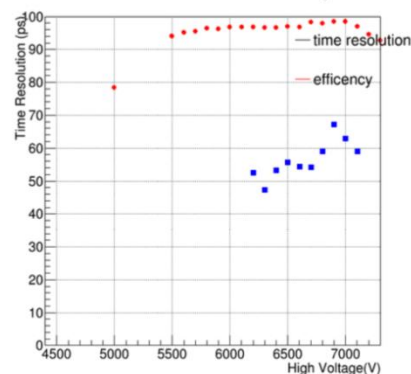
MRPC3a mass prod at Nuctech, Beijing

MRPC3b mass production at USTC/China

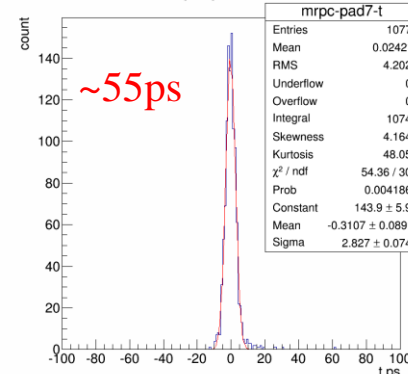
**See talk of Pengfei
Lyu on 23.02 at 10:10**



Time resolution&& efficiency



mrpc-pad7-t



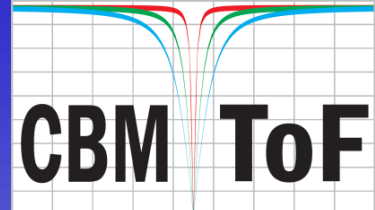
Ingo Deppner

Puerto V

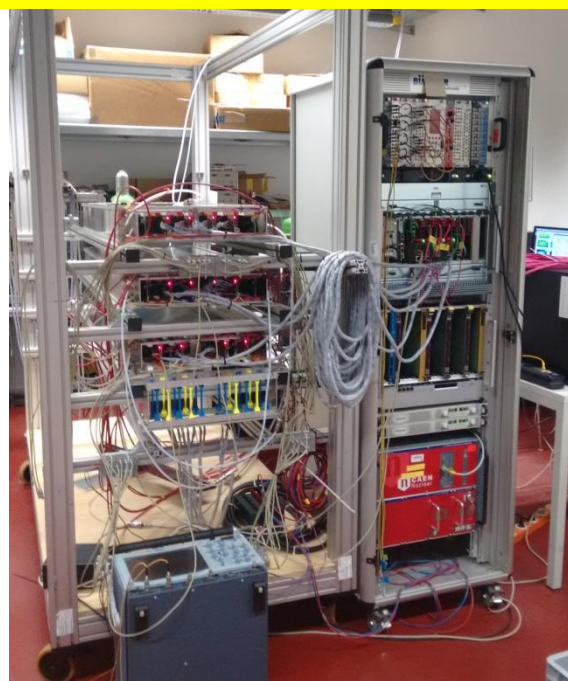
**See talk of Yongjie Sun on 22.02 at 10:40 and
posters of Dongdong Hu, Xinjian Wang, Jian Zhou**



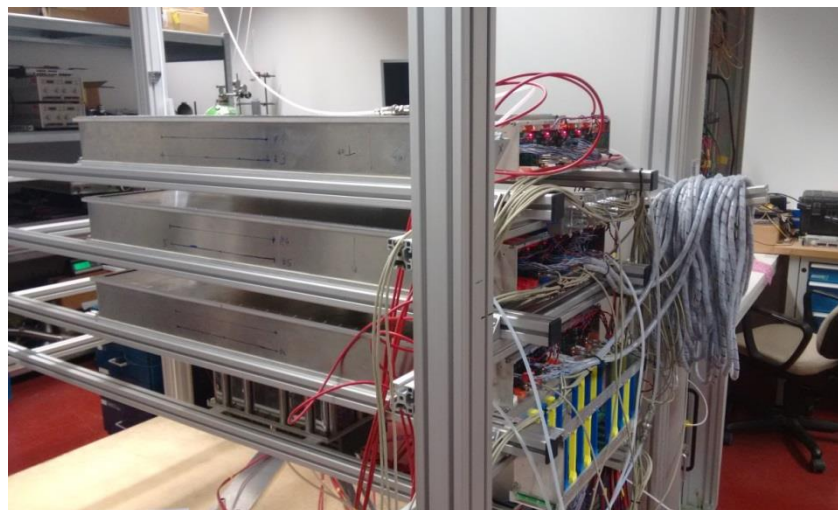
Module integration and cosmic test stand in HD



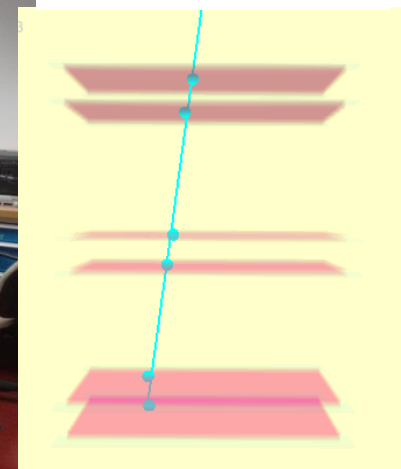
**Multi differential analysis
of counter properties with
cosmic tracks**



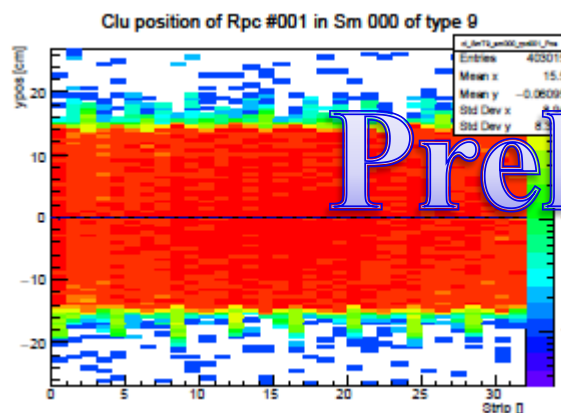
**About 100000 good tracks
per day**



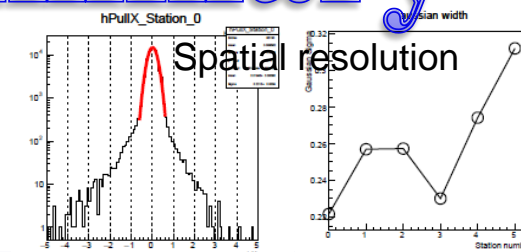
Multiplicity 6 track



Efficiency



Preliminary



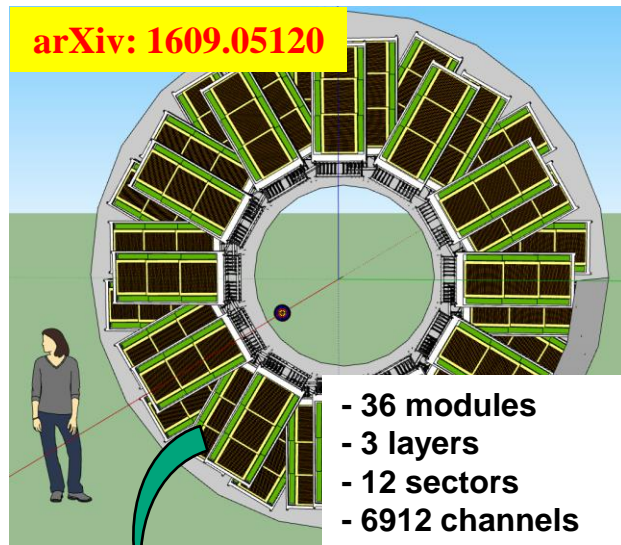
Ingo Deppner

RPC 2018
Puerto Vallarta, 19 - 23.02.2018

15



arXiv: 1609.05120



- 36 modules
- 3 layers
- 12 sectors
- 6912 channels

Time line

- Jan 2018
- Mar. 2018
- Fall 2018
- Fall 2018
- Feb 2019/2020
- Summer 2021

shipping and installation of one sector

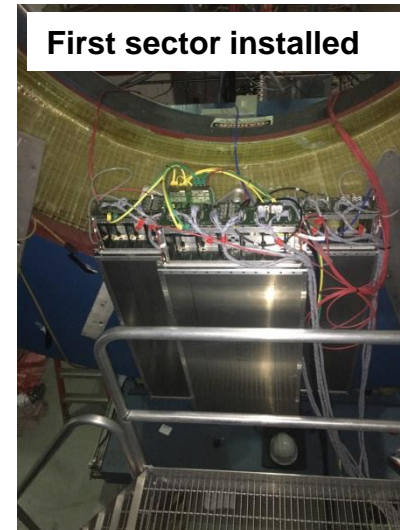
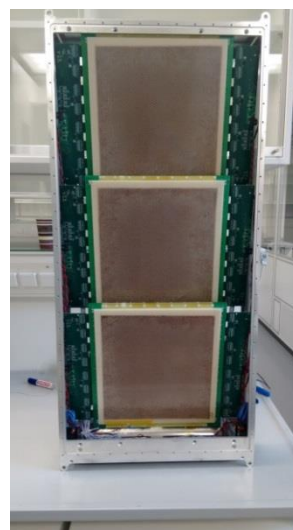
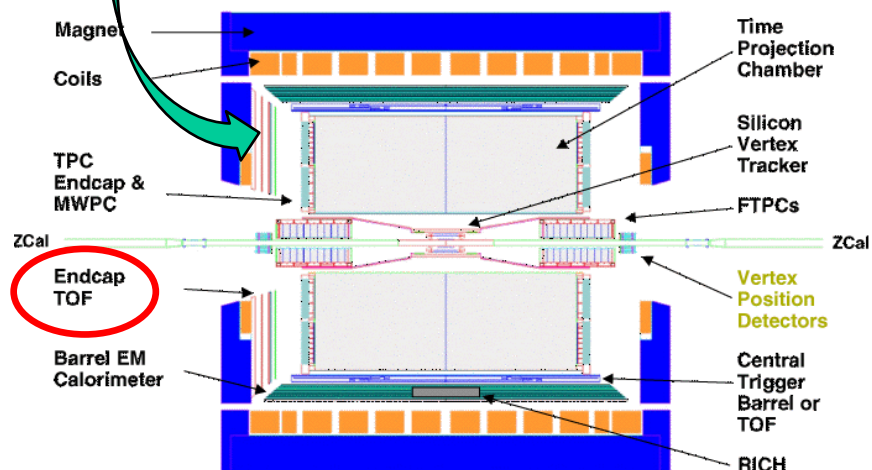
2nd system integration test with one sector by participating in the Run18 beam time in STAR

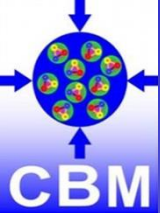
shipping all 33 modules including infrastructure (gas system, LV-, HV-power supply) to BNL

Installation and commissioning

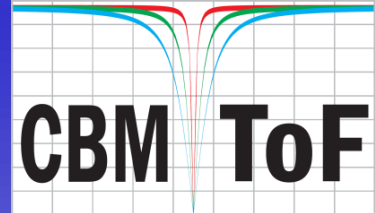
Start of the BES II campaign

Decommissioning and shipping of all modules including infrastructure to FAIR





FAIR Phase 0 – miniCBM



mTOF setup

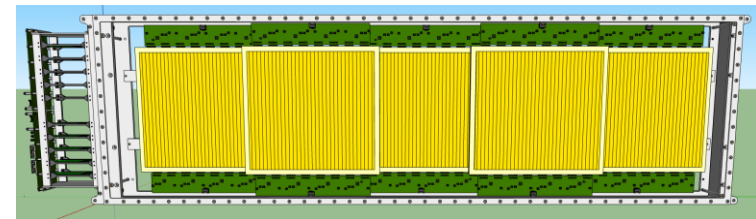
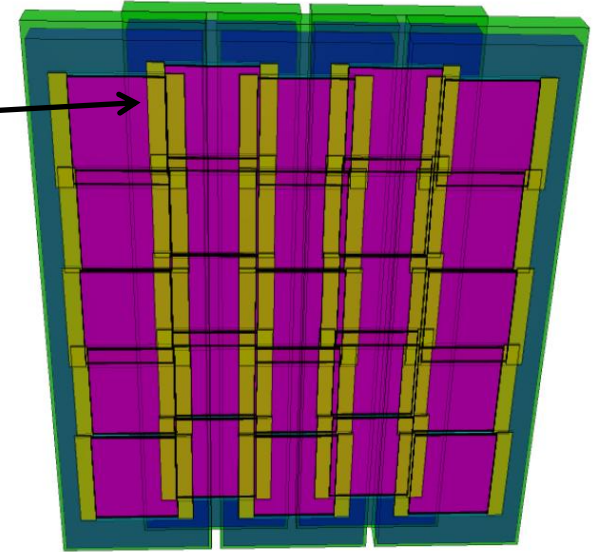
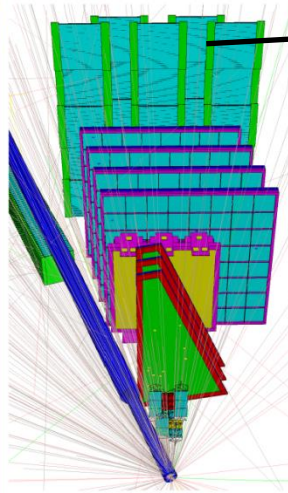
- 25 MRPC3a counters
- 5 M4 modules + 10 CROB(GTBx)
- Active area: $150 \times 120 \text{ cm}^2$
- # of readout channels: 1600
- T0 diamond counter
- **Intended interaction rate: 10 MHz**

Milestones

Counter production finished	Dec. 2017
FEE ready	Mar. 2018
Module production finished	Mar. 2018
Module test with cosmics in HD	Apr. - Jul. 2018
Installation	Jul. 2018
First beam time	Aug 2018

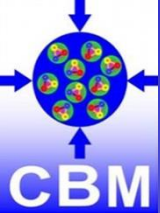


mCBM@SIS18
The CBM Collaboration

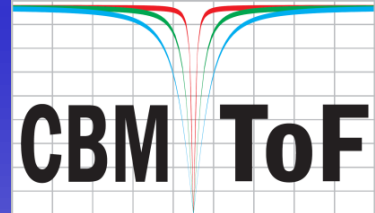


M4 module: 5 MRPC3a counters, 10 PADI, 2 Feed-through PCBs, 10 Get4, 2 backplane PCBs (with GTBx)





Summary



- Counters are fulfilling the specs
- Innovative impedance matching solution developed
- Preproduction for MRPC3/b counter started (QC, QA procedures initiated)
- R&D for BFTC ongoing
- Ultra high rate test still pending \Rightarrow miniCBM
- FAIR phase 0 started - looking forward to physics
- CBM TOF ready for beam in 2023



Thank you for your attention

Contributing institutions:

Tsinghua Beijing,
NIPNE Bucharest,
GSI Darmstadt,
IRI Frankfurt
USTC Hefei,
PI Heidelberg,
ITEP Moscow,
HZDR Rossendorf,
CCNU Wuhan,

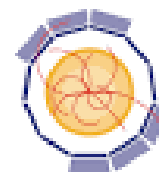
Special thanks go to:

Norbert Herrmann

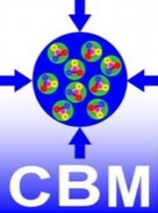


bmb+f

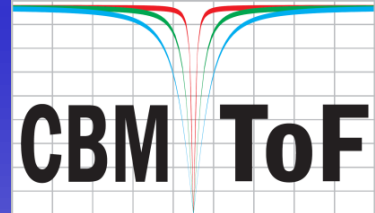
Großgeräte
der physikalischen
Grundlagenforschung



AIDA 2020



Backup



Backup Slides

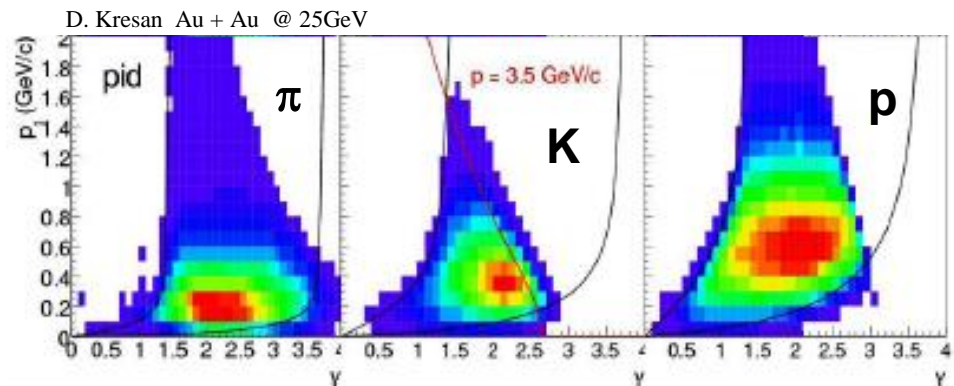
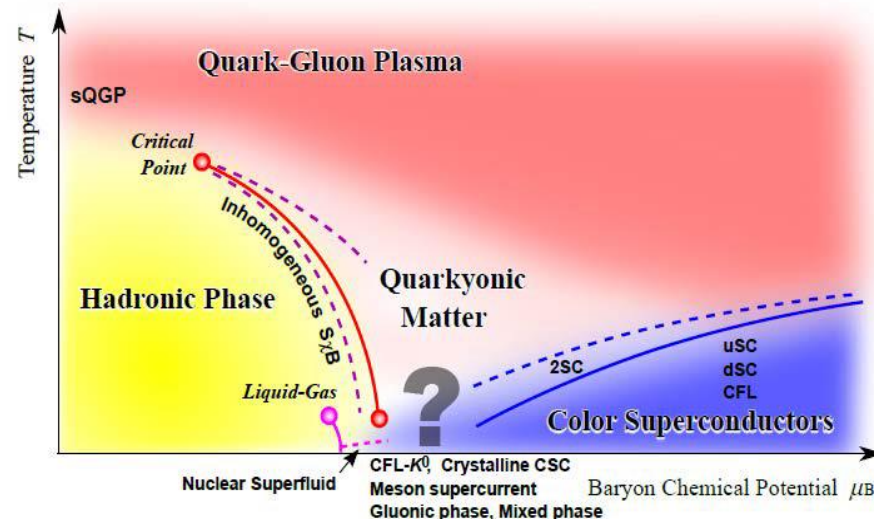


CBM Physics topics

- Deconfinement / phase transition at high ρ_B
- QCD critical endpoint
- The equation-of-state at high ρ_B
- chiral symmetry restoration at high ρ_B

Observables

- excitation function and flow of strangeness and charm
- collective flow of hadrons
- particle production at threshold energies
- excitation function of event-by-event fluctuations
- excitation function of low-mass lepton pairs
- in-medium modifications of hadrons ($\rho, \omega, \phi \rightarrow e+e-(\mu+\mu-), D$)



Kaon acceptance depends critically on TOF resolution



T0 – determination

Diamond start counter

- use HADES development,
- develop DAQ interface,
- limited to reaction rates $\sim 100\text{kHz}$

Software solution

- available for all systems
- needs fast particles from reaction
- demonstrated to work for central and semi-central heavy system

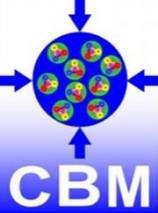
Beam fragmentation counter

- peripheral HI – reaction have fast particles from projectile fragmentation
- equip region E with timing counters (BFTC)

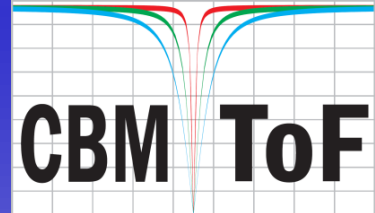
Reaction counter

- needed for high rate pA – reactions (charm at SIS 100)
- reaction counter at polar angles $35^\circ < \theta < 60^\circ$.



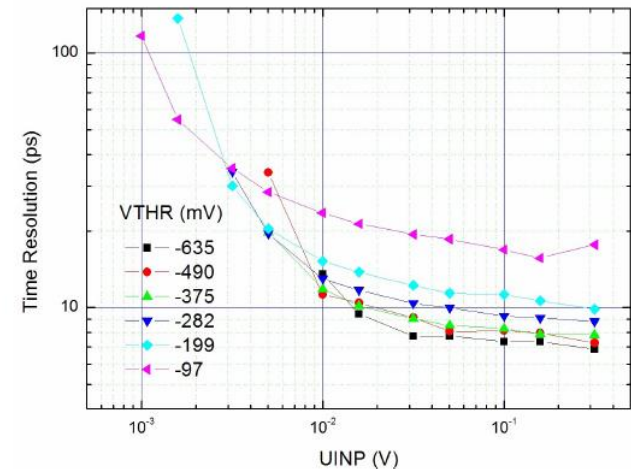


Backup Slides



Main parameters comparison	PADI-1	PADI-2	PADI-6	PADI-8
Channels per chip	3	4	4	8
PA Bandwidth (MHz)	280	293	416	411
PA Voltage Gain	74	87	244	251
Conversion Gain (mV/fC)	6.3	7.8	35	30
Baseline DC offset σ (mV)	6.7	21.9	5.9	1
PA Noise (mV _{RMS})	3.37	2.19	5.82	5.5
Equivalent Noise Charge (e _{RMS})	3512	1753	1039	1145
Threshold type	Extern	Extern	Ext. & DAC	DAC
Threshold dynamics (\pm mV)	Non.lin. 280	Non.lin. 300	Lin. 500	Lin. 750
Input Impedance Range (Ω)	30-450	37 - 370	38 - 165	30 - 160
Power consumption (mW/channel)	21.6	17.4	17.7	17

Table 3.4: Main parameters of the PAD.

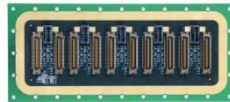


Readout chain

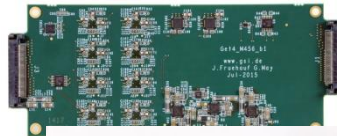
- PADI: Preamplifier board 32 ch



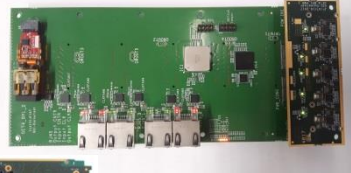
- Feed through PCB



- GET4: TDC board 32 ch



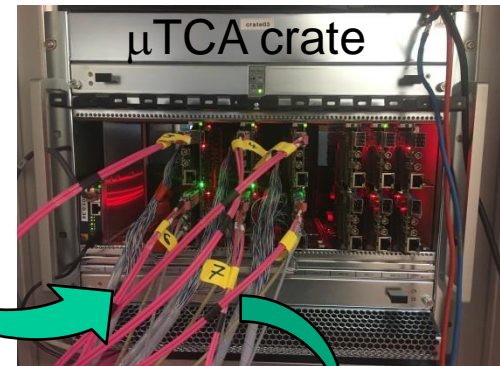
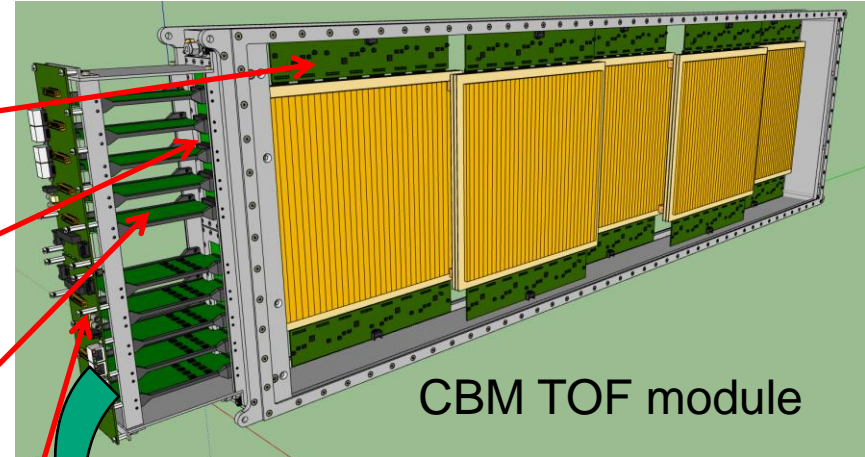
- Backplane with GBTx chip



- AFCK: FPGA board



- FLIB: FPGA PCI express card



HP-PC

